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Application Data Sheet 37 CFR 1.76		Attorney Docket Number	49288.2800			
Application ba	ita officer of of it 1:70	Application Number				
Title of Invention	SUBSTRATE DICING SYSTE DICING METHOD	EM, SUBSTRATE MANUFACTU	JRING APPARATUS, AND SUBSTRATE			
bibliographic data arran This document may be	The application data sheet is part of the provisional or nonprovisional application for which it is being submitted. The following form contains the bibliographic data arranged in a format specified by the United States Patent and Trademark Office as outlined in 37 CFR 1.76. This document may be completed electronically and submitted to the Office in electronic format using the Electronic Filing System (EFS) or the document may be printed and included in a paper filed application.					

Secrecy Order 37 CFR 5.2

Portions or all of the application associated with this Application Data Sheet may fall under a Secrecy Order pursuant to 37 CFR 5.2 (Paper filers only. Applications that fall under Secrecy Order may not be filed electronically.)

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Applic	cant 1							Remove	
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Prefix	Given Name	<u> </u>		Middle Na	me		Fam	nily Name	Suffix
	Yoshitaka						Nish	nio	
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City	Osaka		Co	ountry Of Re	sidencei	JP			
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Mailin	g Address of Ap	plicant:	1						
Addre	ess 1	c/o MITSUBO	SHIE	DIAMOND INC	USTRIAL CO	O., LTD.			
Addre	ess 2	2-12-12, Mina	mi-Ka	aneden, Suita-	city				
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Applic	ation Data \$	Sheet 37 CF	R 1.76		ocket Number	49288	.2800	
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Title of In		JBSTRATE DICI CING METHOD	STRATE DICING SYSTEM, SUBSTRATE MANUFACTURING APPARATUS, AND SUBSTRATE NG METHOD					
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	nt Authority (Inventor			der 35 U.S.C. 1		Party of Interest under 35 U.S.	
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	Hiroyuki					Onari		
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Applicant 5							Remove	
Applicat	nt 5						Dorte of Interest under 25 H.C.	
Applica	nt Authority 🤄	Inventor)Legal Rep	presentative und	der 35 U.S.C. 1	17	Party of Interest under 35 U.S.	C. 118
Applica		Inventor		resentative und	der 35 U.S.C. 1°		y Name	C. 118 Suffix
Applica Prefix	nt Authority (Given Name Kazuhiro	, ,	Mi		der 35 U.S.C. 1		y Name	
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Application Data Sheet 37 CFR 1.76		Attorney Docket Number	49288.2800			
		Application Number				
Title of Invention SUBSTRATE DICING SYSTE DICING METHOD			EM, SUBSTRATE MANUFACTU	JRING APPARATUS,	AND SU	JBSTRATE
Email Address		sshahpar@swlaw.co	m	Add En	nail	Remove Email
Application Information:						

Application Information:

Title of the Invention	SUBSTRATE DICING SYSTEM, SUBSTRATE MANUFACTURING APPARATUS, AND SUBSTRATE DICING METHOD					
Attorney Docket Number	49288.2800 Small Entity Status Claimed ✓					
Application Type	Nonprovisional					
Subject Matter	Utility					
Suggested Class (if any)	ny) Sub Class (if any)					
Suggested Technology C	enter (if any)					
Total Number of Drawing Sheets (if any) 61 Suggested Figure for Publication (ition (if any)		
Publication Information:						
Request Early Publication (Fee required at time of Request 37 CFR 1.219)						
and certify that the inv	ention disclosed in	the attached app	application not be published und- lication has not been and will not agreement, that requires publicati	be the subject of an		

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Please Select One:	Customer Number	US Patent Practitioner	US Representative (37 CFR 11.9)
Customer Number	20322		

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This section allows for the applicant to claim benefit under 35 U.S.C. 119(e), 120, 121, or 365(c). Providing this information in the application data sheet constitutes the specific reference required by 35 U.S.C. 119(e) or 120, and 37 CFR 1.78(a)(2) or CFR 1.78(a) (4), and need not otherwise be made part of the specification.

Prior Application Status	Pending		Remove				
Application Number	Continuity Type	Prior Application Number	Filing Date (YYYY-MM-DD)				
	a 371 of international	PCT/JP04/013962	2004-09-24				
Additional Domestic Priority Data may be generated within this form by selecting the Add button.							

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U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

Application Number Title of Invention SUBSTRATE DICING SYSTEM, SUBSTRATE MANUFACTURING APPARATUS, AND SUBSTRATE DICING METHOD	Application Data Sheet 37 CFR 1.76		Attorney Docket Number	49288.2800	
1 THE OFFICE			Application Number		
	Title of Invention				

This section allows for the applicant to claim benefit of foreign priority and to identify any prior foreign application for which priority is not claimed. Providing this information in the application data sheet constitutes the claim for priority as required by 35 U.S.C. 119(b) and 37 CFR 1.55(a).

Remove						
Application Number	Country i	Parent Filing Date (YYYY-MM-DD)	Priority Claimed			
2003332416	JP	2003-09-24	● Yes ○ No			
Additional Foreign Priority Data may be generated within this form by selecting the Add button.						

Assignee Information:

Providing this information in the application data sheet does not substitute for compliance with any requirement of part 3 of Title 37 of the CFR to have an assignment recorded in the Office.						
Assignee 1			Remove			
If the Assignee is an Orga	nization check here.					
Organization Name	MITSUBOSHI DIAMOND INDUSTRIAL	CO., LTD.				
Mailing Address Informa	tion:					
Address 1	2-12-12, Minami-Kaneden, Suita-c	ity				
Address 2						
City	Osaka	State/Province				
Country JP		Postal Code	564-0044			
Phone Number		Fax Number				
Email Address						
Additional Assignee Data may be generated within this form by selecting the Add button.						

Signature:

A signature of the applicant or representative is required in accordance with 37 CFR 1.33 and 10.18. Please see 37 CFR 1.4(d) for the form of the signature.						
Signature	/Shahpar Shahpar/			Date (YYYY-MM-DD)	2006-03-22	
First Name	Shahpar	Last Name	Shahpar	Registration Number	45875	

This collection of information is required by 37 CFR 1.76. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 23 minutes to complete, including gathering, preparing, and submitting the completed application data sheet form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. **SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.**

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